

TR-82G

RF Transceiver Module Series

Data Sheet

Preliminary

IQRF®
Smarter Wireless. Mesh.

Description

TR-82G is a family of IQRF transceiver modules operating in the 868 MHz and 916 MHz license-free ISM (Industry, Scientific, and Medical) frequency band. Its highly integrated ready-to-use design containing RF circuitry, MCU, integrated LDO regulator, serial EEPROM, and optional onboard antenna requires no external components. Extra-low power consumption fits for battery-powered applications. Enhanced RF IC enables higher receiver sensitivity and RF output power. Flexible MCU pins enable extended functionality and simpler application circuitry and PCB. Extended MCU memories include a built-in operating system which significantly reduces application development time. The optional DPA framework supports mesh network applications.



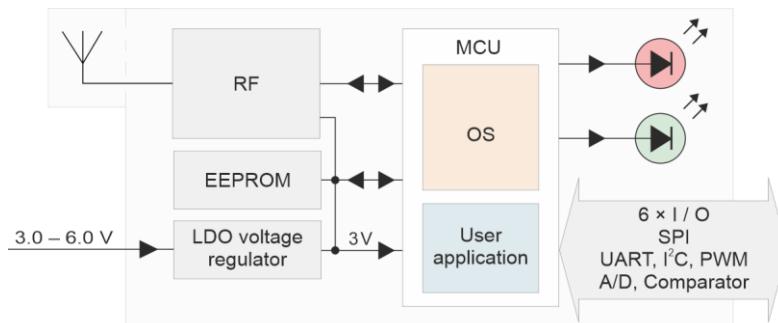
Key features

- Operating system (upgradeable at the user), easy to use
- DPA framework for mesh network applications
- GFSK modulation
- Selectable RF band 868 / 916 MHz, multiple channel
- RF output power 25 mW (14 dBm)
- Effective radiated power 6.3 mW (8 dBm) with on-board antenna
- Enhanced RF sensitivity
- MCU with significantly extended memories for program and data
- Extended MCU resources (interrupt capability and programmable internal pull-ups on all pins, remappable digital peripherals, ...)
- Extra low power consumption, power management modes
- SPI interface supported by OS in background
- Serial EEPROM 256 Kb
- Multiple PWM output
- Extended programmable HW timer options
- Power supply monitoring
- 2 LEDs
- 8 pins, 6 I/Os
- A/D converter (multiple channels) and analog comparator
- Optional on-board antenna or U.FL antenna connector
- SIM card format fits KON-SIM-02 and KON-SIM-01 connectors
- Shielding can (optional)
- Small dimensions

Applications

- Bidirectional RF communication
- Point-to-point or network wireless connectivity
- Telemetry, AMR (automatic meter reading)
- WSN (wireless sensor network)
- Building automation
- Street lighting control
- Wireless monitoring, control and regulation
- Remote data acquisition
- RF connectivity in many other fields
- Also for municipal and indoor areas
- Internet of Things

Block diagram



The information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets your specifications.

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Technical specifications

Typical values unless otherwise stated

Supply voltage (V _{CC})	3.0 V to 6.0 V
LDO output (V _{OUT})	+3 V ± 60 mV (V _{CC} > 3.1 V), 100 mA max.
Supply current	
Deep sleep mode	< 2 µA (All peripherals disabled ³ , RF IC in Standby mode)
Sleep mode	2.3 µA (all peripherals disabled ³ , RF IC in Sleep mode)
Run mode	
RF sleep	1.8 mA
RF ready	3.3 mA
RX mode	
STD	12.5 mA
LP ⁴	190 µA
XLP ⁴	13 µA
TX mode	8 mA – 25 mA (according to RF output power)
Additional LED supply current	About 2 mA per LED. Rough value for brief guidance only.
RF band	868 MHz or 916 MHz (software configurable)
RF channels	See IQRF OS User's guide, Appendix <i>Channel maps</i>
RF data modulation	GFSK (Gaussian Frequency Shift Keying)
RF data transmission bit rate	19.8 kb/s
RF receiver category	1.5 (according to ETSI EN 300 220-1 V3.1.1)
RF sensitivity	-105 dBm ^{5A} , -97 dBm ^{5B} , (STD RX mode, checkRF(0)). See Diagram 3 .
RF output power ^{5A}	Up to 14 dBm (for 50 Ω load), programmable in 8 levels (0 – 7).
Effective radiated power ^{2, 5B}	Up to 8 dBm (868 MHz band), 6 to 8 dBm (916 MHz band). See Table 1 .
RF interface ^{5A}	Single-ended, output impedance 50 Ω
Antenna ^{5B}	PCB meander line, linear polarization, omnidirectional. See Diagram 1 .
RF range ^{2, 5B}	500 m
Input voltage on C1, C2, C5 to C8 pins	0 V to V _{OUT}
A/D converter	10-bit, multiple inputs. Refer to the MCU datasheet.
Ambient environment	Relative humidity 65 % max., chemically indifferent
Operating temperature ¹	-40 °C to +85 °C
Storage temperature	+16 °C to +24 °C (recommended)
Size	25.1 mm x 14.9 mm x 3.3 mm ^{5A} 31.8 mm x 14.9 mm x 3.3 mm ^{5B}

Note 1: RF range may change with lower temperature. Frost, condensation, or humidity over 85 % may disable module functionality. Transceiver suitability should be tested in the final application under real conditions before volume use.

Note 2: Arrangement: Two TR-82GA transceivers plugged directly in DK-EVAL-04A kits, vertically, 1.6 m above the ground, in free space, bidirectional communication.

Test software: [E16-RANGE-TEST](#) example (STD mode, setRFpower(7), checkRF(5), Preamble Quality Test active).

Note 3: Additional current is consumed when a peripheral (e.g. watchdog, Brown-out detection, etc.) is enabled.

Note 4: Depends on interferences.

Note 5: 5A: For TR types without a built-in antenna.

5B: For TR types with built-in antenna.

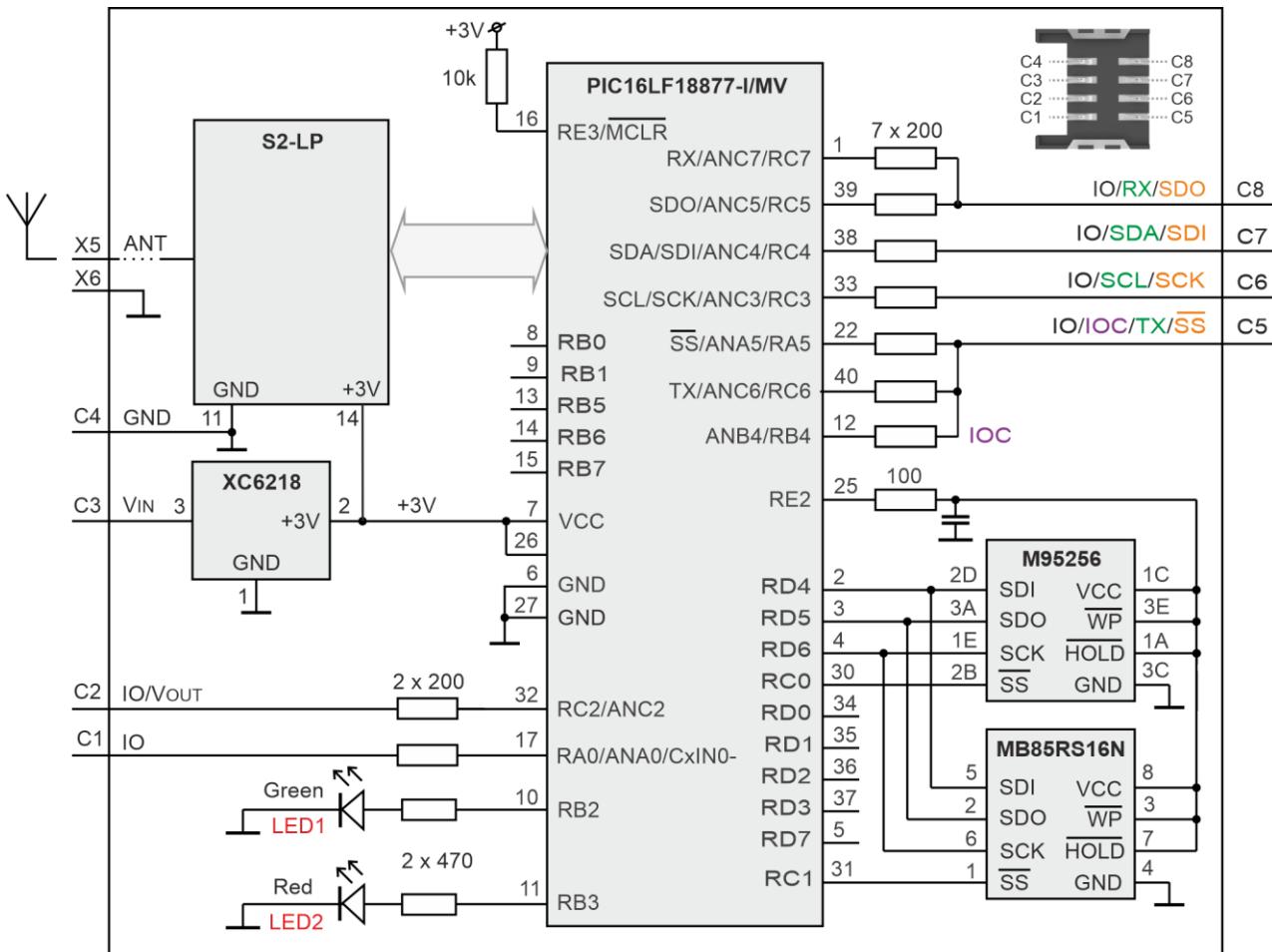
The TR-82GxF (with metal shielding of RF circuitry) must be used in countries where FCC regulations apply.

Absolute maximum ratings

Stresses above the listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation under these or any other conditions beyond those specified is not supported.

Supply voltage (V _{cc})	6.0 V
Voltage on C1, C2, C5 to C8 pins (configured as inputs) vs. GND	-0.3 V to (V _{OUT} + 0.3 V)
Storage temperature	-40 °C to +85 °C
Ambient temperature under bias	-40 °C to +85 °C

Caution: Electrostatic sensitive device. Observe appropriate precautions for handling.

Simplified circuit diagram

Consider that some of the TR pins share several MCU pins connected in parallel. When using multiple functions on these pins, you need to avoid possible collisions.

The colors indicate the constraints on the MCU digital peripheral pin remapping using PPS with respect to IQRF OS and DPA. See [Note 2](#) below and the Application note [AN015 - IQRF HW design](#), chapter *PPS*.

Basic components

Part	Type	Manufacturer	Note
MCU	PIC16LF18877-I/MV	Microchip	
RF IC	S2-LP	STMicroelectronics	
RF balun	BALF-SPI2-01D3	STMicroelectronics	
LDO voltage regulator	XC6218	Torex Semiconductor	
EEPROM	M95256-DFCS6	STMicroelectronics	256 Kb
Shielding can		IQRF Tech	Optional. Required for FCC certification.

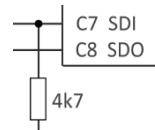
Pin	Name	Description	
C1	IO / C-IN		
	RA0	General I/O pin	
	ANA0	Analog A/D input	
	CxIN0-	Comparator –input	
C2	IO		
	RC2	General I/O pin	
	ANC2	Analog A/D input	
C3	VIN	Power supply voltage	
C4	GND	Ground	
C5	IO/TX/-SS		
	RA5	General I/O pin,	
	-SS ²	SPI Slave select	
	ANA5	Analog A/D input	
	RB4	General I/O pin	
		Interrupt/Wake-up on change (IOC) supported by IQRF OS and DPA. RFPGM / (X)LP mode termination.	
		Dedicated to the DPA menu	
	ANB4	Analog A/D input	
	RC6	General I/O pin	
	TX ²	UART TX	
	ANC6	Analog A/D input	
C6	IO/SCK/SCL		
	RC3	General I/O pin	
	SCK ²	SPI clock input	
	SCL ²	I ² C clock	
	ANC3	Analog A/D input	
C7 ¹	IO/SDI/SDA		
	RC4	General I/O pin	
	SDI ²	SPI data input	
	SDA ²	I ² C data	
	ANC4	Analog A/D input	
C8 ¹	IO/RX/SDO		
	RC5	General I/O pin	
	SDO ²	SPI data output	
	ANC5	Analog A/D input	
	RC7	General I/O pin	
	RX ²	UART RX	
	ANC7	Analog A/D input	
X5	ANT	Antenna input (except TR-82GAxxx types)	
P1–P5		For manufacturer only	
M1, M2		Holes for possible mechanical fixation	

All MCU pins connected to TR I/O pins (C1, C2, C5, C6, C7, and C8) are equipped with the interrupt on change capability and programmable pull-up resistor and can be used as analog inputs for A/D converter.

Note 1: Pin C8 is used as output and pin C7 as input during the initial approximately 200 ms boot-up (after TR reset) to detect a possible request to enter the programming mode (PGM - wired upload via SPI). After reset, the OS generates a determinate sequence on the C8 pin. If this sequence is copied to the C7, the OS jumps to the PGM bootloader. (The PGM mode is indicated by the short red LED flashing every 2 s.)

This must be taken into account to avoid collisions with application circuitry connected to these pins.

The C7 pin must not be interconnected to C8 or left unconnected or without a **defined level** on its input. This level must be arranged **by application hardware**. If the application circuitry ensures no such level, a **pull-down resistor on the C7 pin** must be used otherwise a **cross-talk** between C8 and C7 may cause an unintentional switching to PGM.



Note 2: All MCU pins dedicated to internal digital peripherals (e.g. UART, I²C, SPI, PWM, timers, analog comparator output, etc.) are remappable in SW. See the MCU datasheet, chapter *Peripheral Pin Select (PPS)*, and the application note [AN015 - IQRF HW design](#), chapter *PPS*. The list above denotes only the pins assigned to UART, I²C, and SPI by default. Other remappable peripherals (e.g. PWM or analog comparator output) are not denoted there.

See the Application note [AN015 - IQRF HW design](#).

RF range

Refer to the Application note [AN014 – RF range](#). RF range strongly depends on the following design aspects:

- **Hardware:**
 - Construction of the devices (especially TR location within the device, PCB layout, ground planes, conductive areas, and bulk objects such as metallic parts and batteries in the nearest surroundings, with respect to possible reflections and counterpoise effect). To achieve an efficient range and reliable connectivity, no parts impacting the range must be placed close to the built-in meander antenna. Even non-conductive parts including a mainboard PCB under the antenna can significantly impact the range.
 - The physical arrangement of devices (especially mutual orientations of antennas with respect to polarization and radiation patterns).
- **Application software:**
 - RF output power is selectable from 8 levels
 - To increase immunity to RF noise, incoming RF signals can be filtered according to signal strength. See the *IQRF OS Reference guide*, function `checkRF`, and configuration parameter *RX filter*.

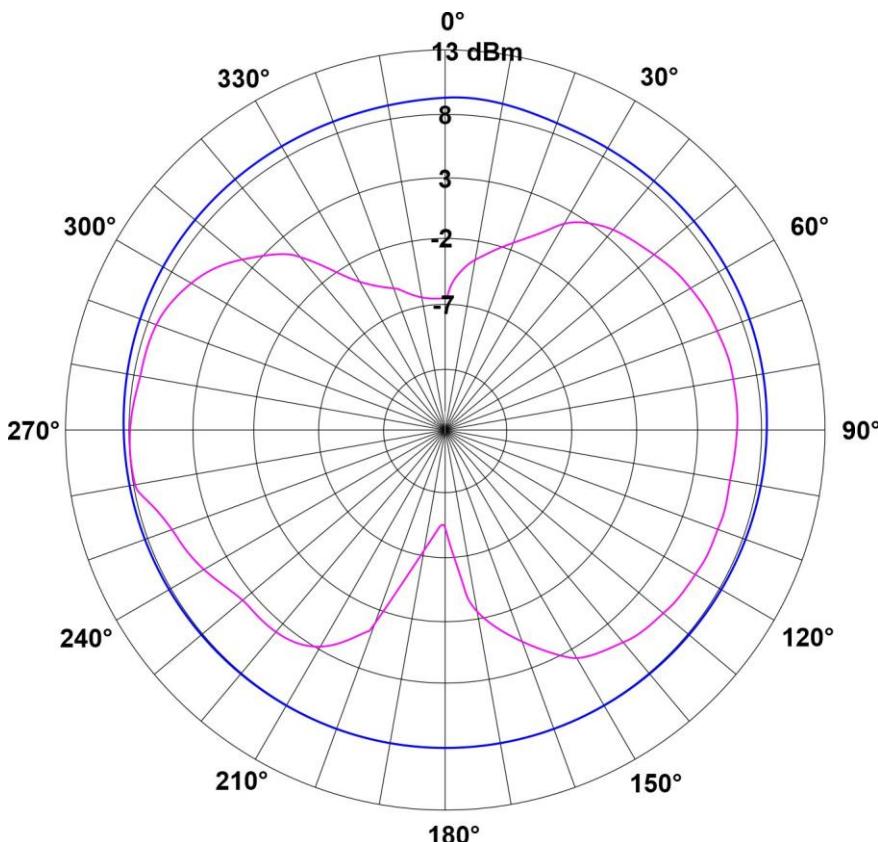


Diagram 1: TR-8xGA RF output power [in dBm] vs. antenna orientation (radiation patterns).

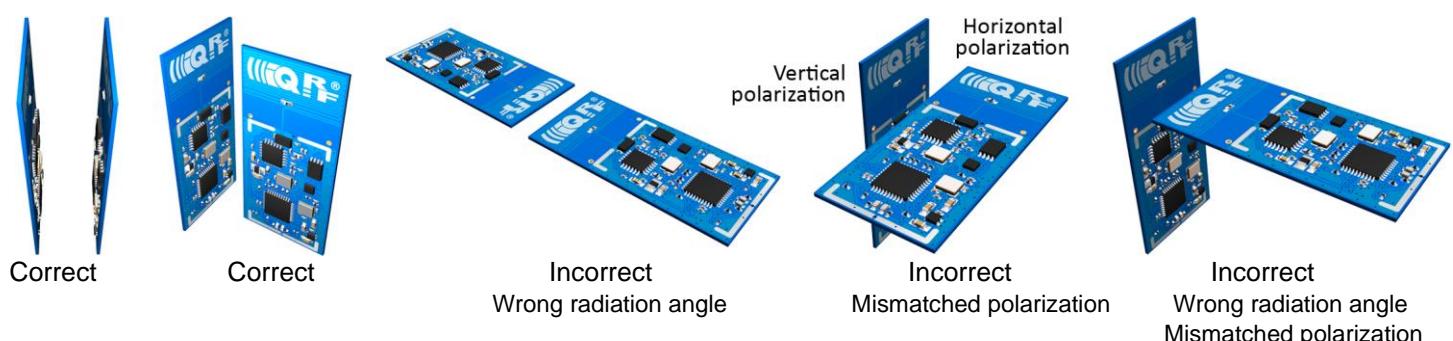


Vertical antenna



Horizontal antenna

Examples of the correct and incorrect arrangement of TR-82GA pairs:



The **Effective radiated power (ERP)** in the 868 MHz band is constant for all channels. The ERP in the 916 MHz band decreases to higher channels. The ERP drop on channel 255 relative to the power on channel 0 is 2 dBm.

level	ERP [dBm]				
	868 MHz		916 MHz		
	Channels 0 to 67	Channel 0	Channel 104	Channel 255	
7		8	8	7	6
6		5	5	4	3
5		0	0	-1	-2
4		-4	-4	-5	-6
3		-10	-10	-11	-12
2		-16	-16	-17	-18
1		-28	-28	-29	-30
0		-36	-36	-37	-38

Table 1: TR-82GA effective radiated power (ERP) vs. level in the `setRFpower(level)` function.

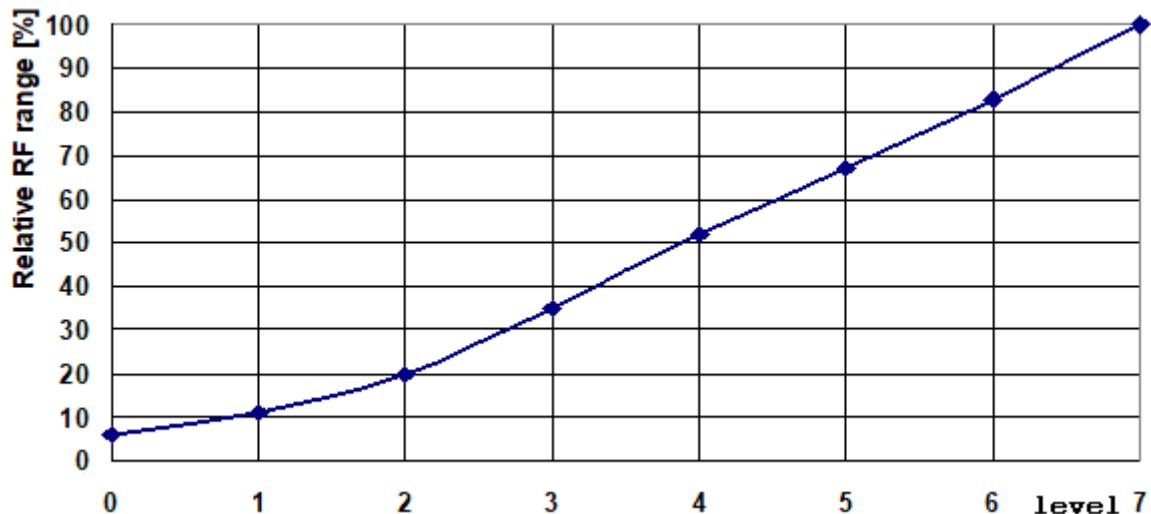


Diagram 2: TR-82G(A) relative RF range vs. level in the `setRFpower(level)` function.

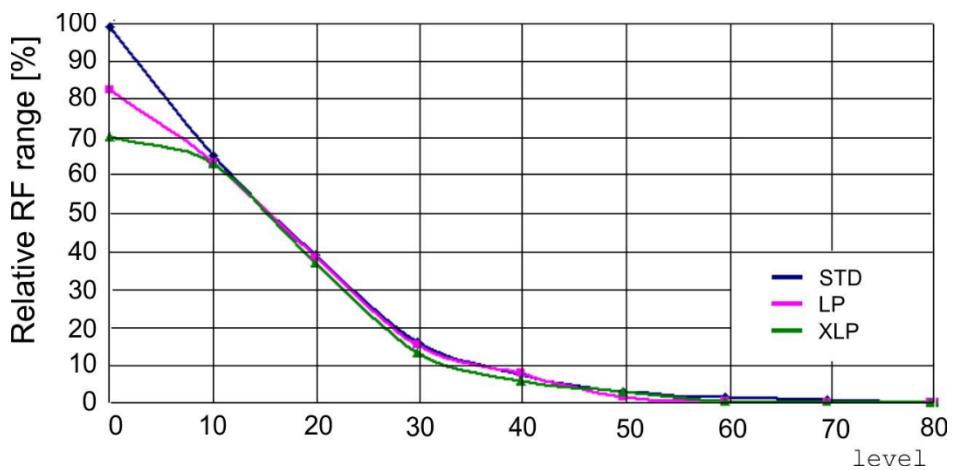


Diagram 3: Relative RF range vs. level in the `checkRF(level)` function in STD, LP, and XLP RX modes.

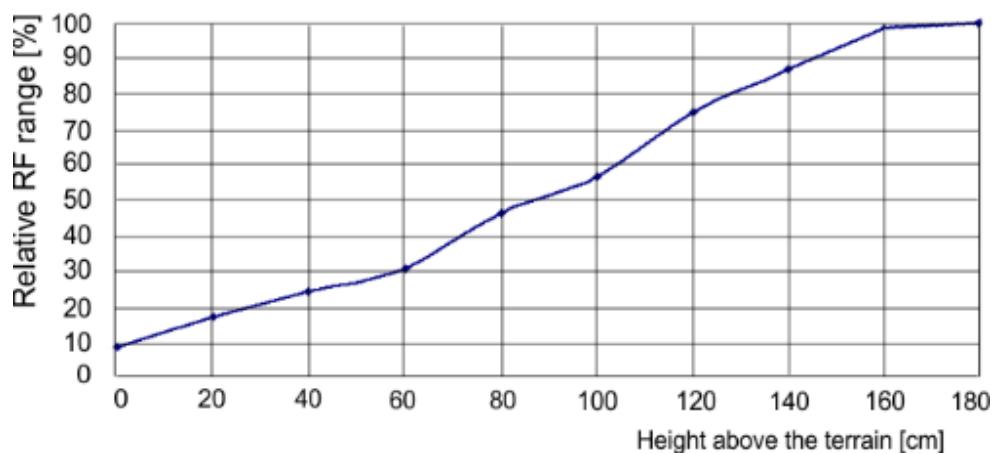
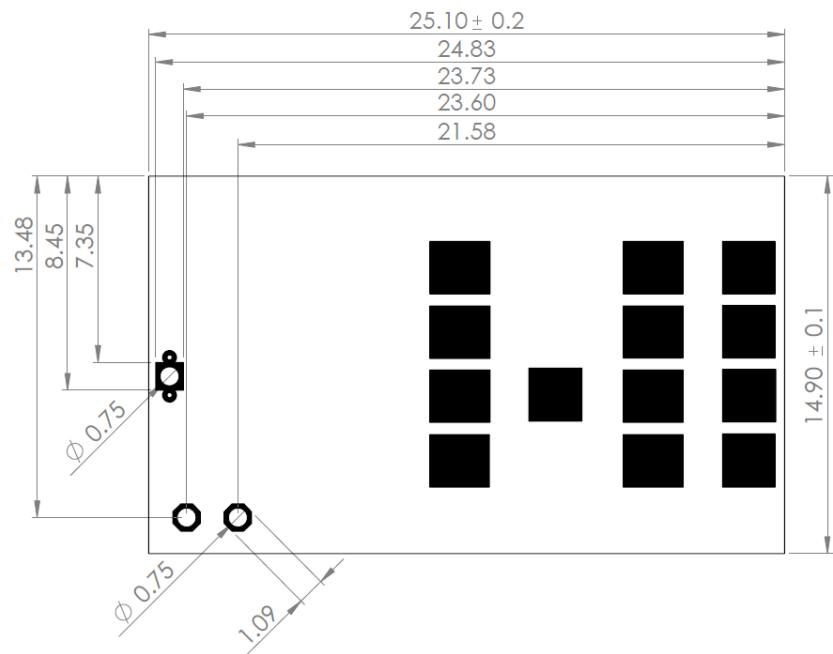


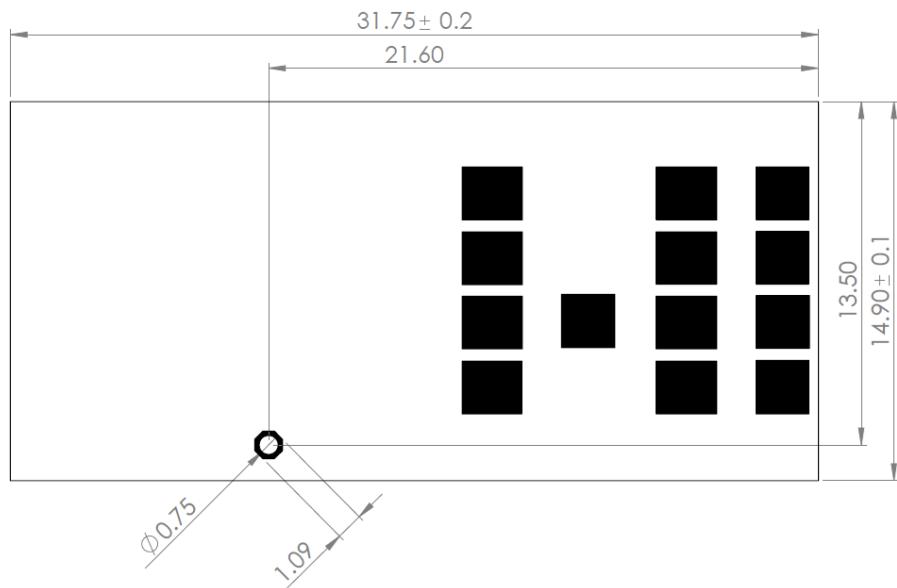
Diagram 4: TR-82GA relative RF range vs. antenna height above the ground, 868 MHz and 916 MHz bands.

Mechanical drawings

TR-82G(C)



TR-82GA



Top view, Units: mm

Hardware revision

TR-82G v1.00

First release with PCB for TR-82G non-A variants.

TR-82GA v1.10

First release with PCB for TR-82GA variants. Without mechanical hole M1.

Application

Users have to ensure observing local provisions and restrictions relating to the use of short-range devices **by software**, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

See the Application notes [AN015 - IQRF HW design](#) and [AN014 – RF range](#), and IQRF video tutorial set.

Assembly

TR-82Gx modules should be mounted in the SIM connector. They are not intended for SMT reflow soldering. Recommended SIM connector: KON-SIM-02 or KON-SIM-01.

It is not allowed to connect wires to pads (except the M1, M2, and X5 pads) by soldering.

Sealing

In case of sealing or protecting TR modules against a harsh environment by coating, encapsulating, or potting using a lacquer, gel, or other filling matter, refer to the Application note [AN015 - IQRF HW design](#), chapter *Sealing*.

Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

DPA framework

See the DPA Framework technical guide.

Application software

See IQRF Quick start guide and IQRF application examples.

Programming (upload)

There are the following possibilities to upload an application program in TR-82Gx modules:

- Wired upload with TR-82Gx plugged via the SIM connector in the CK-USB-04(A) programmer.
- For TR-82Gx modules populated in an application:
 - Wired upload
 - Using the CK-USB-04A programmer. See the CK-USB-04A User's guide.
 - Completely arranged by the user application. See the *IQRF SPI Technical guide*, chapter *Programming mode*.
 - Wireless upload: See the IQRF OS User's guide, Appendix *RPGM – RF programming*™.

Product information**Ordering codes****TR-82G A F**

Transceiver series _____

Shielding can (necessary for FCC certification)

Antenna options _____

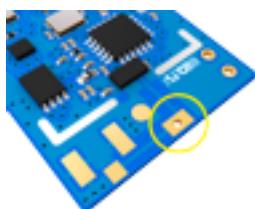
nil - soldering pad-hole (no antenna, no U.FL connector)

A - PCB antenna

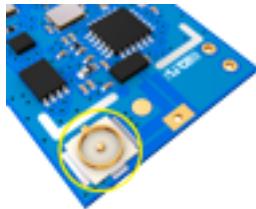
C - U.FL connector (mini-coax)

Examples:

Type	Antenna option	Shielding can	FCC compliant
TR-82G	Soldering pad-hole	–	–
TR-82GC	U.FL connector	–	–
TR-82GA	PCB antenna	–	–
TR-82GCF	U.FL connector	Yes	Yes



TR-82G



TR-82GC



TR-82GA



TR-82GCF

Document history

240425 Preliminary.

Sales and Service

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Technology and development

www.iqrf.org

E-mail (technical matters): support@iqrf.org

Partners and distribution

www.iqrf.org/partners

Quality management

ISO 9001 : 2016 certified

The product complies with the essential requirements and other relevant provisions of directives 2004/108/EC (EMC), 2014/53/EU (RED), 2018/738/EU (ROHS), when used under the conditions of use specified by the manufacturer.



Harmonized standards or other relevant technical specifications used on the basis of which conformity is declared:

Radio spectrum: ČSN ETSI EN 301 489-3 V2.1.1

FCC directives Part 15 Low Power Communication Device Transmitter. FCC ID: R24-TR8xGx.

EMC: ČSN ETSI EN 301 489-1 V2.2.3

ČSN EN 55032 ed. 2

ČSN EN 55035

Safety: ČSN EN IEC 62368-1 ed. 2+A11

RoHS: ČSN EN IEC 63000

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